

MOSFETs Silicon P-Channel MOS (U-MOSVI)

# **SSM3J356R**

## **1. Applications**

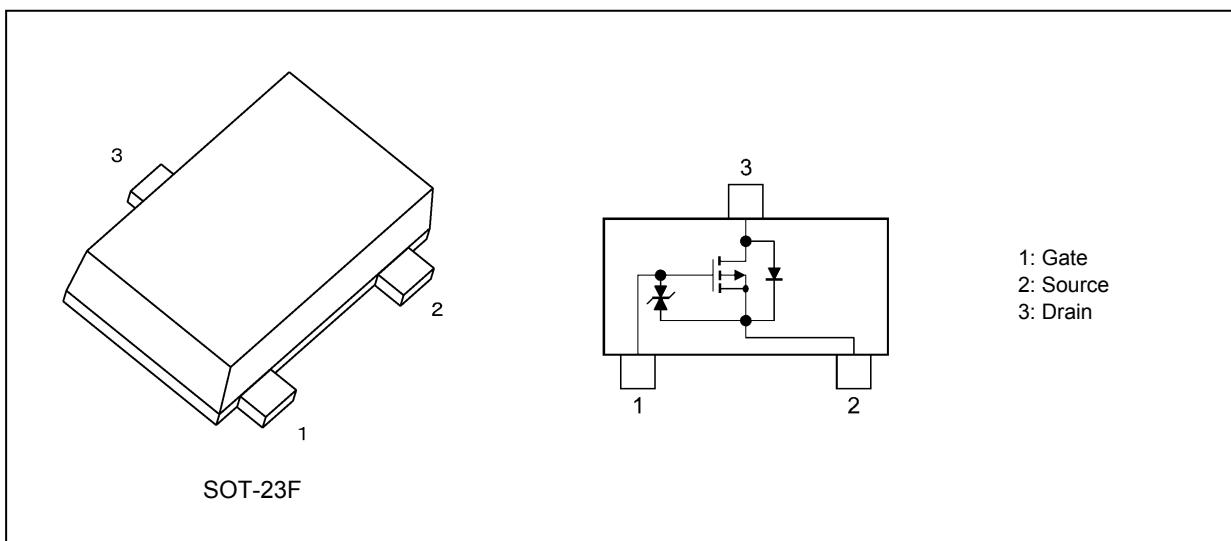
- Power Management Switches

## **2. Features**

- (1) 4 V gate drive voltage.
- (2) Low drain-source on-resistance  
:  $R_{DS(ON)} = 400 \text{ m}\Omega$  (max) (@ $V_{GS} = -4.0 \text{ V}$ )  
 $R_{DS(ON)} = 300 \text{ m}\Omega$  (max) (@ $V_{GS} = -10 \text{ V}$ )
- (3) AEC-Q101 qualified (Note 1)

Note 1: For detail information, please contact to our sales.

## **3. Packaging and Pin Assignment**



Start of commercial production  
2015-09

4. Absolute Maximum Ratings (Note) (Unless otherwise specified,  $T_a = 25^\circ\text{C}$ )

Characteristics	Symbol	Rating	Unit
Drain-source voltage	$V_{DSS}$	-60	V
Gate-source voltage	$V_{GSS}$	-20/+10	
Drain current (DC)	$I_D$	-2	A
Drain current (pulsed)	$I_{DP}$	-6	
Power dissipation	$P_D$	1	W
Power dissipation ( $t \leq 10 \text{ s}$ )		2	
Channel temperature	$T_{ch}$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: Ensure that the channel temperature does not exceed  $150^\circ\text{C}$ .

Note 2: Repetitive rating; pulse width limited by maximum channel temperature.

Note 3: Device mounted on a  $25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}$  FR4 glass epoxy board (Cu pad:  $645 \text{ mm}^2$ )

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

Note: The MOSFETs in this device are sensitive to electrostatic discharge. When handling this device, the worktables, operators, soldering irons and other objects should be protected against anti-static discharge.

Note: The channel-to-ambient thermal resistance,  $R_{th(ch-a)}$ , and the drain power dissipation,  $P_D$ , vary according to the board material, board area, board thickness and pad area. When using this device, be sure to take heat dissipation fully into account.

## 5. Electrical Characteristics

### 5.1. Static Characteristics (Unless otherwise specified, $T_a = 25^\circ\text{C}$ )

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	$I_{GSS}$	$V_{GS} = -16\text{ V}/+10\text{ V}$ , $V_{DS} = 0\text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Drain cut-off current	$I_{DSS}$	$V_{DS} = -60\text{ V}$ , $V_{GS} = 0\text{ V}$	—	—	-10	$\mu\text{A}$
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = -1\text{ mA}$ , $V_{GS} = 0\text{ V}$	-60	—	—	V
Drain-source breakdown voltage (Note 1)	$V_{(BR)DSX}$	$I_D = -1\text{ mA}$ , $V_{GS} = 10\text{ V}$	-50	—	—	
Gate threshold voltage	$V_{th}$	$V_{DS} = -10\text{ V}$ , $I_D = -1\text{ mA}$	-0.8	—	-2.0	V
Drain-source on-resistance (Note 2)	$R_{DS(ON)}$	$I_D = -1.0\text{ A}$ , $V_{GS} = -4.0\text{ V}$	—	280	400	$\text{m}\Omega$
		$I_D = -1.0\text{ A}$ , $V_{GS} = -4.5\text{ V}$	—	270	360	
		$I_D = -1.0\text{ A}$ , $V_{GS} = -10\text{ V}$	—	240	300	
Forward transfer admittance (Note 2)	$ Y_{fs} $	$V_{DS} = -10\text{ V}$ , $I_D = -1\text{ A}$	—	4.7	—	S

Note 1: If a reverse bias is applied between gate and source, this device enters  $V_{(BR)DSX}$  mode. Note that the drain-source breakdown voltage is lowered in this mode.

Note 2: Pulse measurement.

### 5.2. Dynamic Characteristics (Unless otherwise specified, $T_a = 25^\circ\text{C}$ )

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	$C_{iss}$	$V_{DS} = -10\text{ V}$ , $V_{GS} = 0\text{ V}$ , $f = 1\text{ MHz}$	—	330	—	$\text{pF}$
Reverse transfer capacitance	$C_{rss}$		—	25	—	
Output capacitance	$C_{oss}$		—	40	—	
Switching time (turn-on time)	$t_{on}$	$V_{DD} = -30\text{ V}$ , $I_D = -1.0\text{ A}$ $V_{GS} = 0\text{ to }-4.5\text{ V}$ , $R_G = 10\Omega$ Duty $\leq 1\%$ , $V_{IN}$ : $t_r, t_f < 5\text{ ns}$ , Common source, See Chapter 5.3.	—	29	—	$\text{ns}$
Switching time (turn-off time)	$t_{off}$		—	48	—	

### 5.3. Switching Time Test Circuit

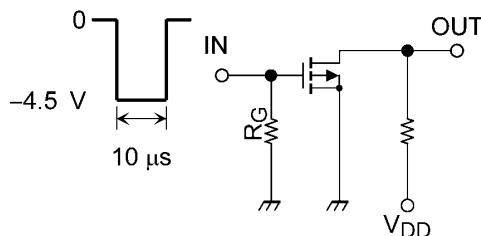


Fig. 5.3.1 Switching Time Test Circuit

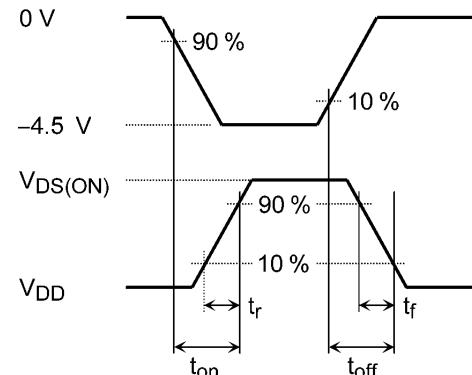


Fig. 5.3.2 Input Waveform/Output Waveform

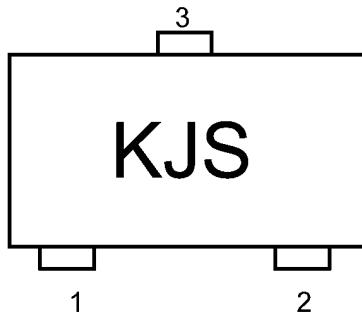
### 5.4. Gate Charge Characteristics (Unless otherwise specified, $T_a = 25^\circ\text{C}$ )

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	$Q_g$	$V_{DD} = -48\text{ V}$ , $V_{GS} = -10\text{ V}$ , $I_D = -2.0\text{ A}$	—	8.3	—	$\text{nC}$
Gate-source charge 1	$Q_{gs1}$		—	0.8	—	
Gate-drain charge	$Q_{gd}$		—	1.7	—	

**5.5. Source-Drain Characteristics (Unless otherwise specified,  $T_a = 25^\circ\text{C}$ )**

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Diode forward voltage (Note 1)	$V_{DSF}$	$I_D = 2.0 \text{ A}, V_{GS} = 0 \text{ V}$	—	0.9	1.2	V

Note 1: Pulse measurement.

**6. Marking**

## 7. Characteristics Curves (Note)

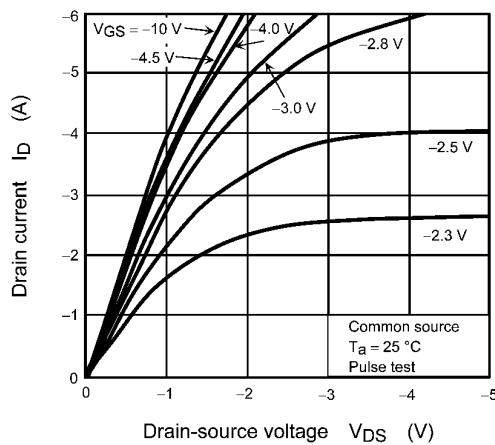


Fig. 7.1  $I_D$  -  $V_{DS}$

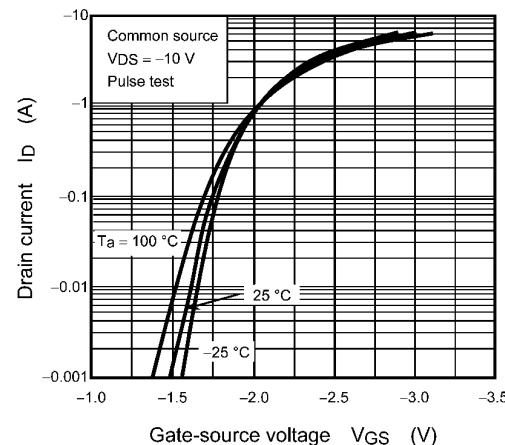


Fig. 7.2  $I_D$  -  $V_{GS}$

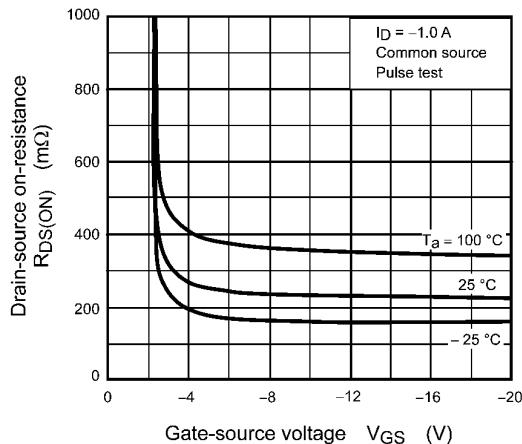


Fig. 7.3  $R_{DS(ON)}$  -  $V_{GS}$

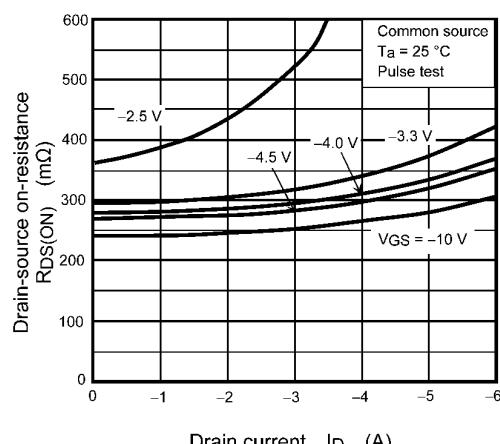


Fig. 7.4  $R_{DS(ON)}$  -  $I_D$

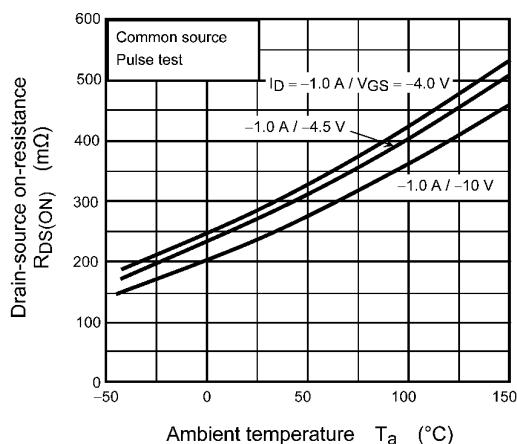


Fig. 7.5  $R_{DS(ON)}$  -  $T_a$

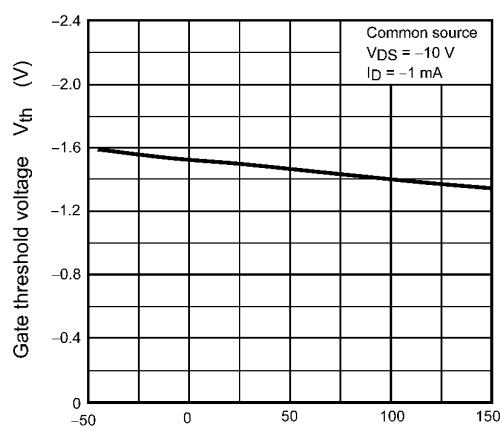


Fig. 7.6  $V_{th}$  -  $T_a$

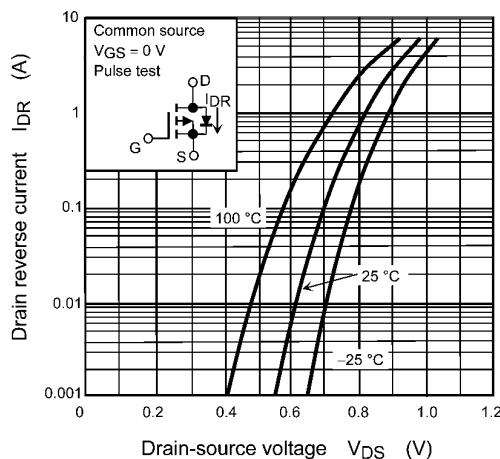
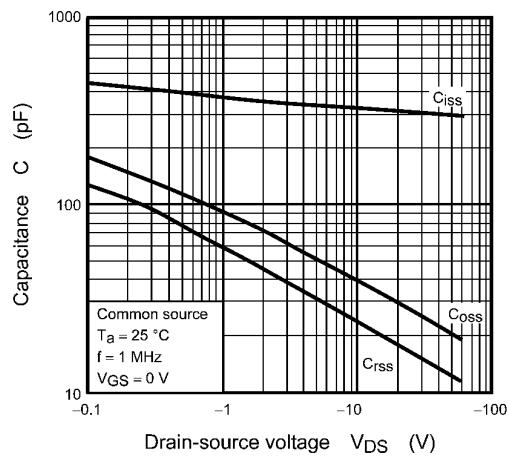
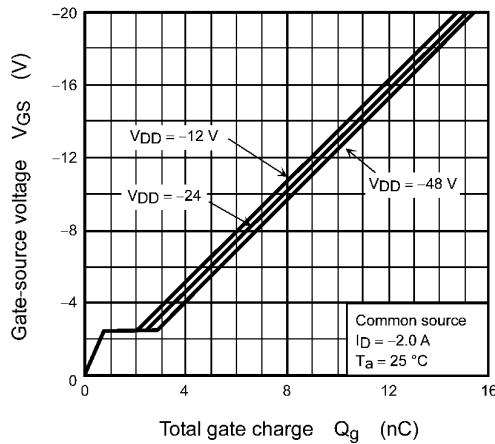
Fig. 7.7 IDR - V<sub>DS</sub>Fig. 7.8 C - V<sub>DS</sub>

Fig. 7.9 Dynamic Input Characteristics

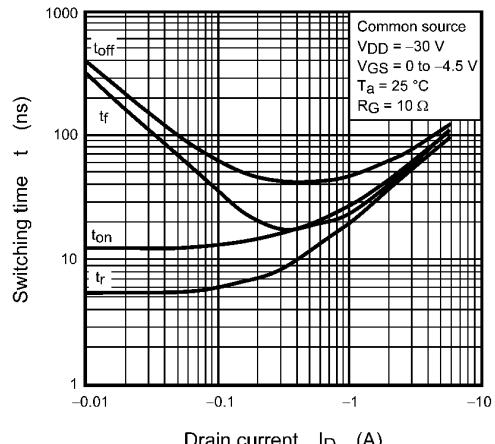
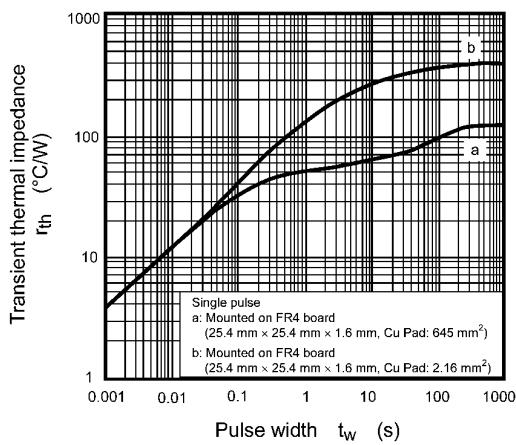
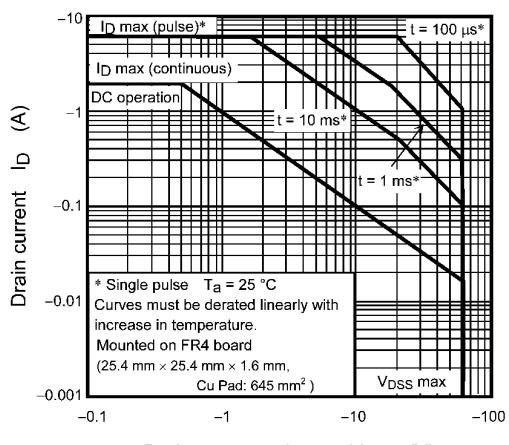
Fig. 7.10 t - I<sub>D</sub>Fig. 7.11 r<sub>th</sub> - t<sub>w</sub>

Fig. 7.12 Safe Operating Area

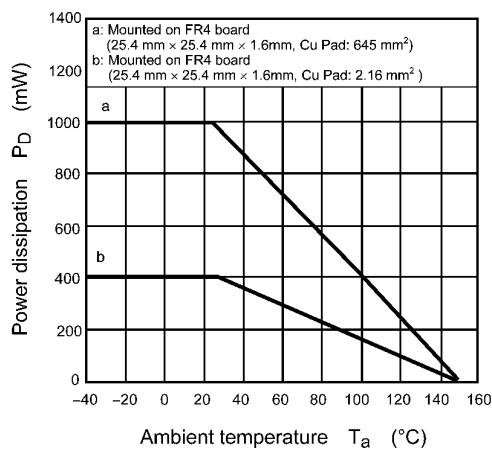
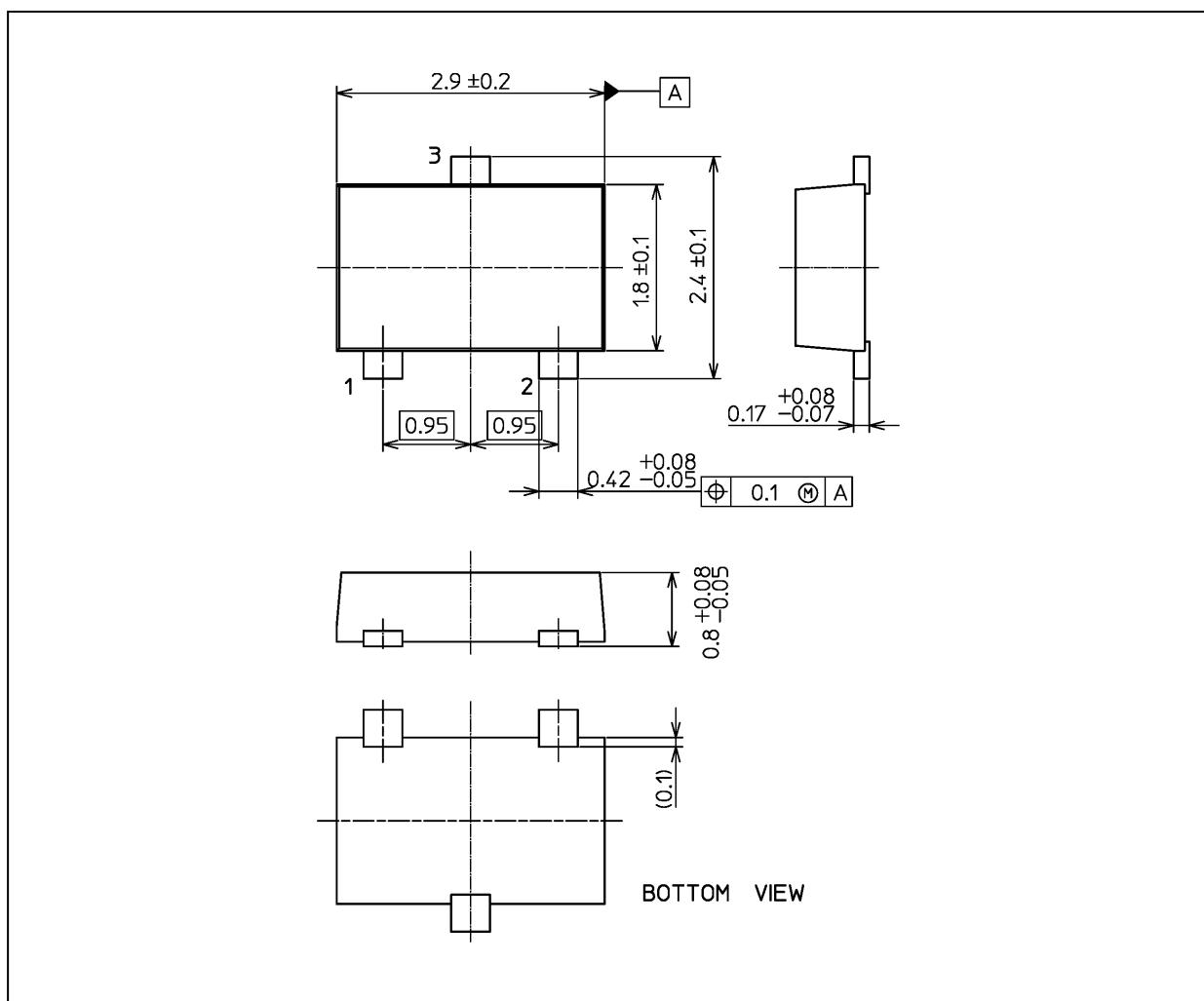


Fig. 7.13  $P_D$  -  $T_a$

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

## Package Dimensions

Unit: mm



Weight: 0.011 g (typ.)

Package Name(s)
TOSHIBA: 2-3Z1S
Nickname: SOT-23F

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